

## FEATURES

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Glass passivated chip junction
- Low forward voltage drop, High current capability
- Soft recovery improves EMC performance
- High temperature soldering guaranteed:260°C/10 seconds at terminals
- Component in accordance to RoHS 2015\863\EU

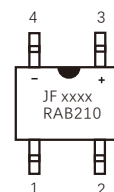
## MECHANICAL DATA

- Case:ABS molded plastic body
- Terminals: Plated leads solderable per MIL-STD-750,method 2026
- Mounting Position: Any

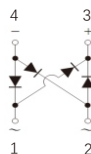
## TYPICAL APPLICATIONS

Used in AC/DC bridge full wave rectification for SMPS, lighting ballaster, adapter, charger, home appliances, office equipment, and telecommunication applications.

### ABS



Pin Diagram



Internal Schematic

Marking  
JF:Logo  
XXXX:Data code  
RABS210:Type

## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Rating at 25°C ambient temperature unless otherwise specified. Single phase ,half wave ,60Hz,resistive or inductive load. For capacitive load,derate current by 20%.)

Parameters		Symbols	RABS22	RABS24	RABS26	RABS28	RABS210	Units
Maximum Recurrent Peak Reverse Voltage		V <sub>RRM</sub>	200	400	600	800	1000	Volts
Maximum RMS Voltage		V <sub>RMS</sub>	140	280	420	560	700	Volts
Maximum DC Blocking Voltage		V <sub>DC</sub>	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current		I <sub>(AV)</sub>	2.0					Amp
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC method)		I <sub>FSM</sub>	60					Amps
Rating for fusing (t=8.3mS)		I <sup>2</sup> t	14.9					A <sup>2</sup> S
Maximum DC Reverse Current at rated DC blocking voltage	T <sub>J</sub> =25°C	I <sub>R</sub>	5.0					μA
	T <sub>J</sub> =125°C		200					
Maximum Instantaneous Forward Voltage at 2.0A		V <sub>F</sub>	1.3					Volts
Typical thermal resistance(Note 2)		R <sub>θJA</sub> R <sub>θJC</sub>	62.5 25					°C/W
Maximum reverse recovery time(Note1)		trr	150		250	500		ns
Operating junction and storage temperature range		T <sub>J</sub> T <sub>STG</sub>	-55 to +150					°C

Note: 1.Test conditions: IF=0.5A,IR=1.0A,IRR=0.25A.

2.Device mounted on FR-4 substrate, 1"×1", 2oz, single-sided, PC boards with 0.56"×0.73" copper pad.

## AVAILABLE PACK INFORMATION

Product code	Pack	Reel Size (mm)	Quantity (pcs/reel)	Quantity (reel/box)	Quantity (box/carton)	Quantity (K/carton)
RABS22-RABS210-ABS	T/R	Φ330	3000	2	8	48

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

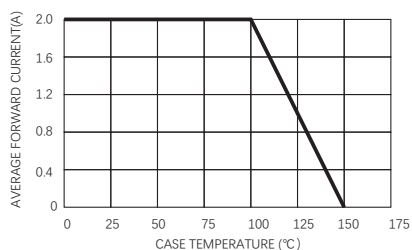


FIG.2-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

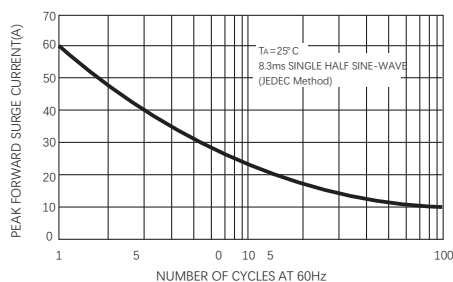


FIG.3 -TYPICAL REVERSE CHARACTERISTICS

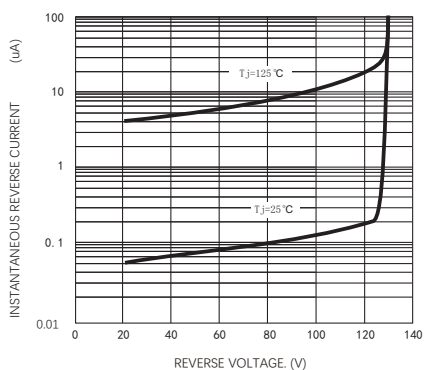
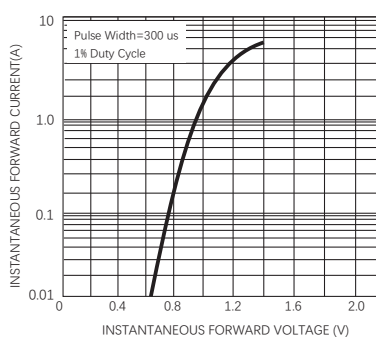
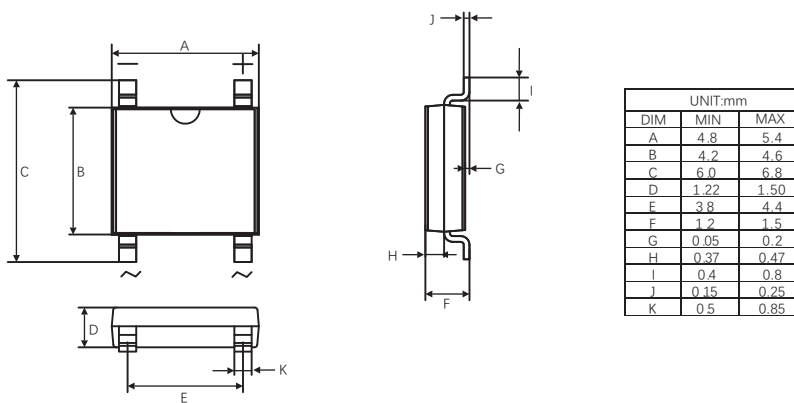


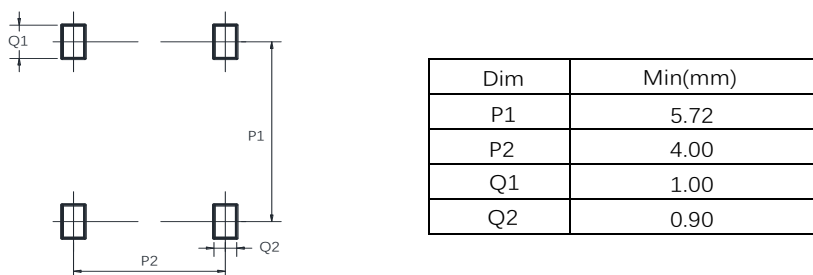
FIG4-TYPICAL FORWARD CHARACTERISTICS



## ABS



## Suggested Pad Layout



## Friendship Reminder

- JiNan JingHeng (hereinafter referred to as JH) reserves the right to make changes to this document and its products and specifications at anytime without notice.
- Customers should obtain and confirm the latest product information and specifications before final design, purchase or use.
- JH makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does JH assume any liability for application assistance or customer product design.
- JH does not warrant or accept any liability with products which are purchased or used for any unintended or unauthorized application.
- No license is granted by implication or otherwise under any intellectual property rights of JH.
- JH's products are not authorized for use as critical components in life support devices or systems without express written approval of JH.